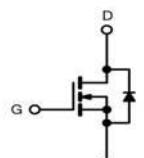
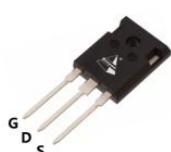




N-channel Power MOSFET

PRODUCT SUMMARY

V_{DS} (V) at T_J max.	700	
$R_{DS(on)}$ max. at 25°C (mΩ)	$V_{GS}=10V$	38
Q_g max. (nC)	250	
Q_{gs} (nC)	33	
Q_{gd} (nC)	65	
Configuration	single	



TO-247

Schematic diagram

Features

- New Technology For High Voltage Device
- ID=69A(Vgs=10V)
- Ultra Low Gate Charge
- Improved dv/dt Capability
- RoHS Compliant

Applications

- Switching Mode Power Supplies (SMPS)
- Power factor correction (PFC)
- Uninterruptible Power Supply (UPS)

ORDERING INFORMATION

Device	SPA65R38G
Device Package	TO-247
Marking	65R38G

ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain to Source Voltage	V_{DSS}	650	V
Continuous Drain Current (@ $T_c=25^\circ\text{C}$)	I_D	69 ⁽¹⁾	A
Continuous Drain Current (@ $T_c=100^\circ\text{C}$)		43 ⁽¹⁾	A
Drain current pulsed ⁽²⁾	I_{DM}	276 ⁽¹⁾	A
Gate to Source Voltage	V_{GS}	± 30	V
Single pulsed Avalanche Energy ⁽³⁾	E_{AS}	2300	mJ
MOSFET dv/dt ruggedness (@ $V_{DS}=0\text{~}400\text{V}$)	dv/dt	30	V/ns
Peak diode Recovery dv/dt ⁽⁴⁾	dv/dt	20	V/ns
Total power dissipation (@ $T_c=25^\circ\text{C}$)	P_D	625	W
Derating Factor above 25°C		5	W/°C
Operating Junction Temperature & Storage Temperature	T_{STG}, T_J	-55 to + 150	°C
Maximum lead temperature for soldering purpose	T_L	260	°C

Notes

1. Drain current is limited by maximum junction temperature.
2. Repetitive rating : pulse width limited by junction temperature.
3. L = 47mH, $I_{AS} = 10\text{A}$, $V_{DD} = 50\text{V}$, $R_G=25\Omega$, Starting at $T_J = 25^\circ\text{C}$
4. $I_{SD} \leq I_D$, $di/dt = 100\text{A/us}$, $V_{DD} \leq BV_{DSS}$, Starting at $T_J = 25^\circ\text{C}$



THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal resistance, Junction to case	R _{thjc}	0.2	°C/W
Thermal resistance, Junction to ambient	R _{thja}	34	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain to source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	650	--	--	V
Breakdown voltage temperature coefficient	ΔBV _{DSS} / ΔT _J	I _D =250uA, referenced to 25°C	--	0.7	--	V/°C
Drain to source leakage current	I _{DSS}	V _{DS} =650V, V _{GS} =0V	--	--	1	uA
		V _{DS} =650V, T _C =125°C	--	--	10	uA
Gate to source leakage current, forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V	--	--	100	nA
Gate to source leakage current, reverse		V _{GS} =-30V, V _{DS} =0V	--	--	-100	nA
On Characteristics						
Gate threshold voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	2.5	--	4.5	V
Drain to source on state resistance	R _{DSON}	V _{GS} =10V, I _D = 33A	--	32	38	mΩ
Forward Transconductance	G _f	V _{DS} = 30 V, I _D = 33A	--	52	--	S
Dynamic Characteristics						
Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =200V, f=1MHz	--	7850	--	pF
Output capacitance	C _{oss}		--	250	--	
Reverse transfer capacitance	C _{rss}		--	12	--	
Turn on delay time	t _{d(on)}	V _{DS} =380V, I _D =33A , R _G =18Ω, V _{GS} =10V	--	84	--	ns
Rising time	t _r		--	77	--	
Turn off delay time	t _{d(off)}		--	510	--	
Fall time	t _f		--	120	--	
Total gate charge	Q _g	V _{DS} =520V, V _{GS} =10V, I _D =33A	--	200	250	nC
Gate-source charge	Q _{gs}		--	32	--	
Gate-drain charge	Q _{gd}		--	64	--	

SOURCE TO DRAIN DIODE RATINGS CHARACTERISTICS

Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous source current	I _S	Integral reverse p-n Junction diode in the MOSFET	--	--	69	A
Pulsed source current	I _{SM}		--	--	276	A
Diode forward voltage drop.	V _{SD}	I _S =69A, V _{GS} =0V	--	0.9	1.3	V
Reverse recovery time	T _{rr}	I _S =33A, V _{GS} =0V, dI _F /dt=100A/us	--	508	--	ns
Reverse recovery Charge	Q _{rr}		--	10	--	uC

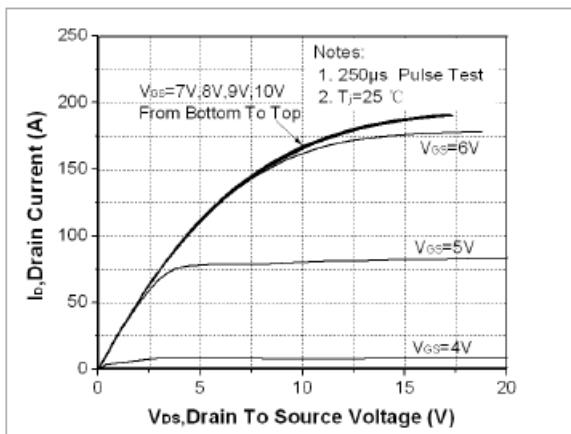
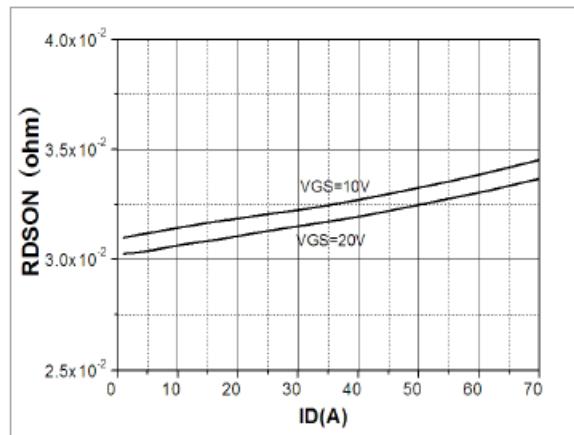
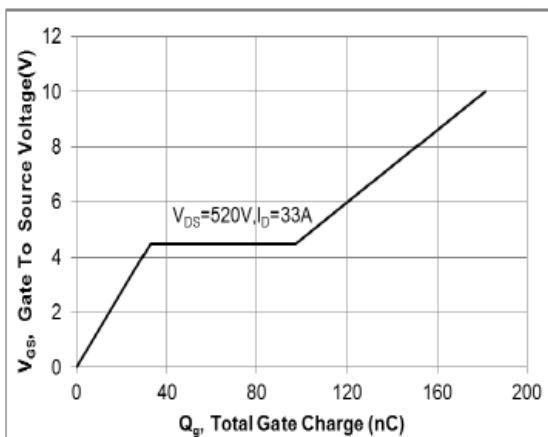
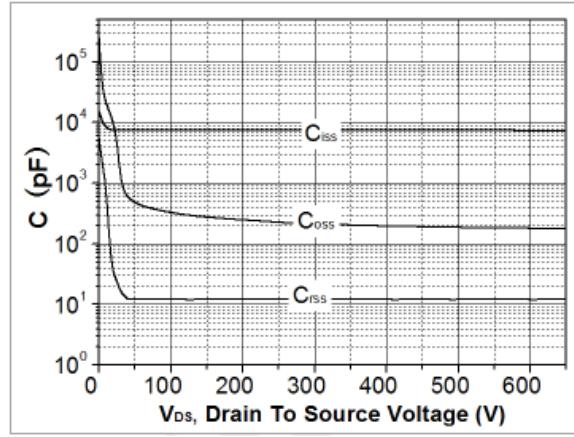
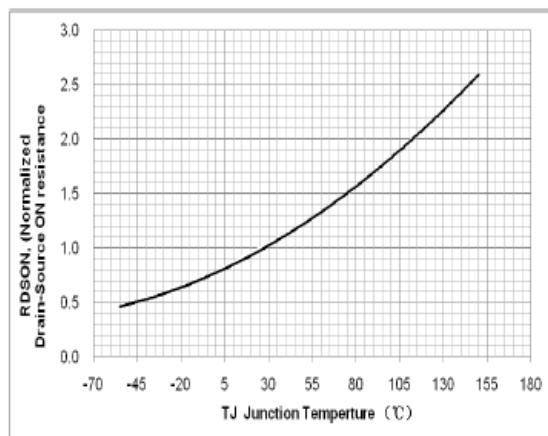
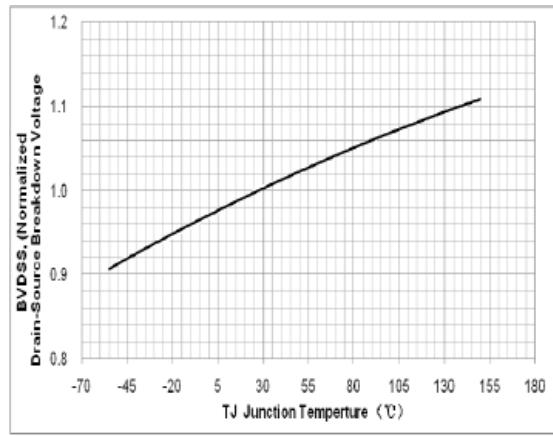
Fig1. Output characteristics

Fig2. R_{DSON} vs. Drain Current and Gate Voltage

Fig3. Gate charge characteristics

Fig 4. Capacitance Characteristics

Fig 5. $R_{DS(ON)}$ vs junction temperature

Fig 6. Temperature vs. Drain-to-Source Voltage


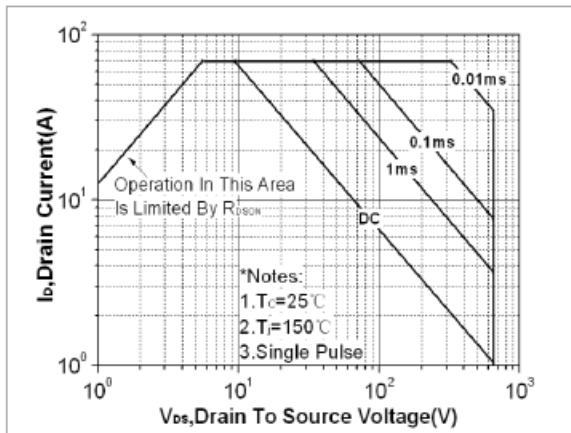
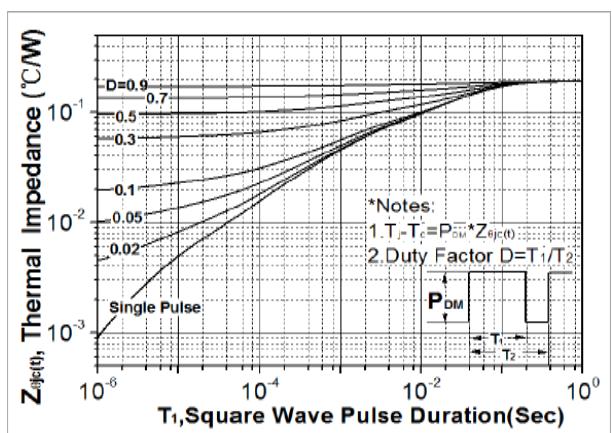
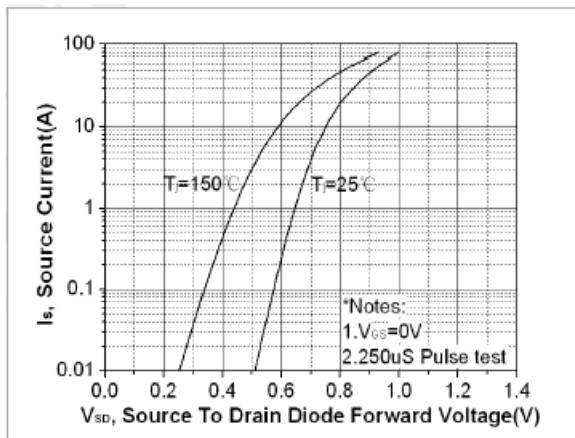
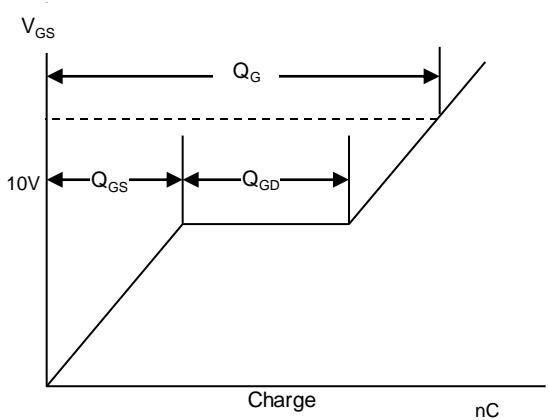
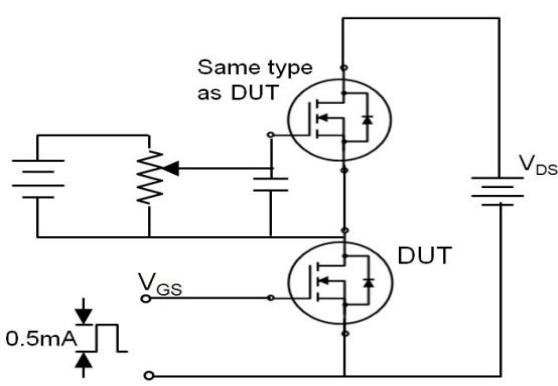
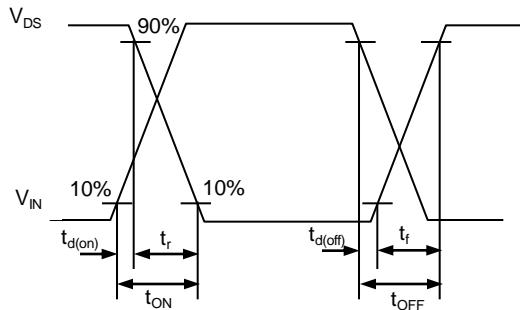
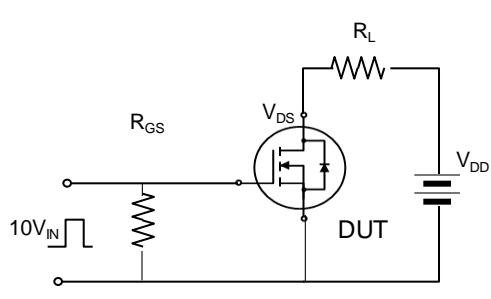
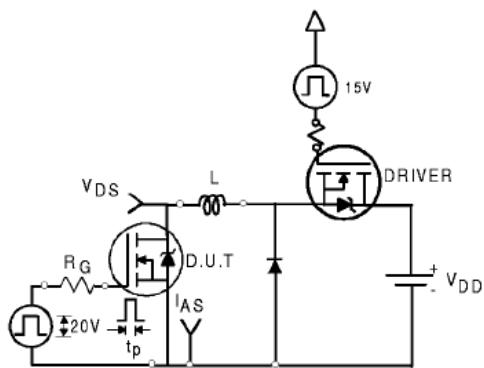
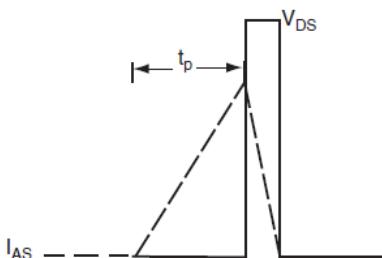
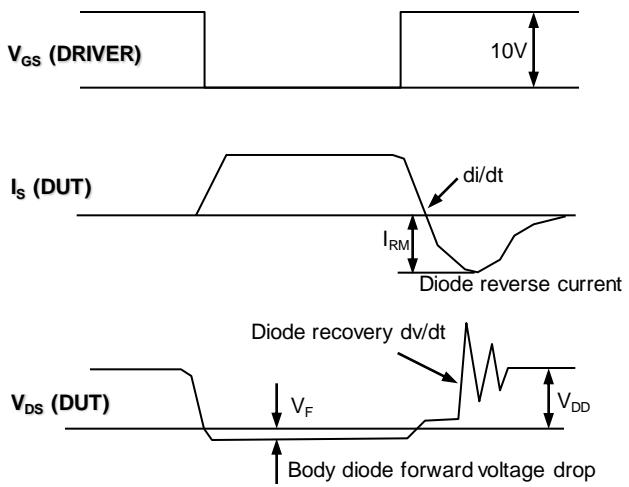
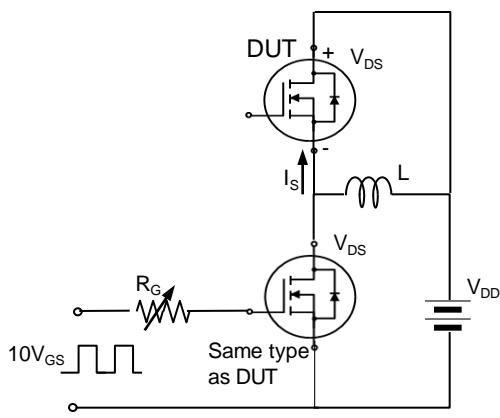
Fig 7 . Safe operating area

Fig 8 . Transient thermal impedance

Fig 9. Forward characteristics of reverse diode

Fig 10. Gate charge test circuit & waveform


Fig 11. Switching time test circuit & waveform

Fig 12. Unclamped Inductive switching test circuit & waveform


$$E_{AS} = \frac{1}{2} L I_{AS}^2$$


Fig 13. Peak diode recovery dv/dt test circuit & waveform




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